

## Electronic Acknowledgement Receipt

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<b>Application Number:</b>	09516082
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<b>Confirmation Number:</b>	3545
<b>Title of Invention:</b>	SEMICONDUCTOR DEVICE COMPRISING A THIN FILM TRANSISTOR COMPRISING A SEMICONDUCTOR THIN FILM AND METHOD OF MANUFACTURING THE SAME
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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Request for Continued Examination (RCE)	RCEsel163.pdf	145514	no	1
			ff35114320139e1b89046d413f9079313a11d464		
Warnings:					
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2	Information Disclosure Statement Letter	IDScoverletterSEL163.pdf	133365	no	3
			92b832d11c8920c19c5669a0974ffdfcbe6290f6		
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3	1.501 Submission by Patent Owner	1449SEL163.pdf	104226	no	1
			e1af7a522f8bb08e019a4a17626b3dd3dc266817		
Warnings:					
Information:					
4	Foreign Reference	JP62143027.pdf	363209	no	7
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Warnings:					
Information:					
5	Foreign Reference	JP3194895.pdf	412058	no	8
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Warnings:					
Information:					
6	Foreign Reference	JP10104663.pdf	1816703	no	17
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7	Foreign Reference	JP2000155312.pdf	1127617	no	13
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8	Fee Worksheet (PTO-06)	fee-info.pdf	8236	no	2
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<b>Total Files Size (in bytes):</b>				4110928	
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